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- (A) Method of manufacturing a metal matrix.
- ① A method of manufacturing a metal matrix which is suitable for the production of synthetic resin information disks, in which a master disk consisting of a glass supporting plate (1) and a photoresist layer (2) comprising an information track is coated with an electroless Ni-layer (6) and an electrodeposited Ni-layer (7). A matrix having an excellent surface quality is obtained by a pre-treatment of the master disk with a detergent and an aminosilane.

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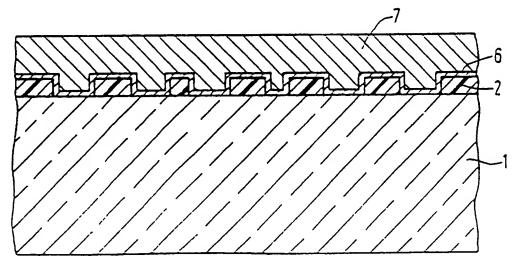


FIG. 3

Method of manufacturing a metal matrix.

The invention relates to a method of manufacturing a metal matrix which comprises an information track on at least one side, in which a master disk comprising a photoresist layer in which an information track has been provided on the side of the onotoresist layer is provided in an electroless nickel-plating bath with a nickel ayer on which a metal ayer is provided by electrodecosition and the resulting metal shell in which the information track of the proctoresist layer has been copied, is separated from the master disk.

The metal shell comprises the electrodeposited metal layer and the electroless-deposited nickel layer bonded thereto and comprises the negative copy of the information track of the master disk. The first negative copy in metal is termed father matrix and may serve as a matrix for the production of synthetic resin information disks. Usually, further metal matrices are derived from the father matrix by electrodeposition.

The synthetic resin information bisks which are manufactured by means of the metal matrices, are synthetic resin disks having an optically readable information track which comprises video and/or audio information. On the side of the information track the disk is coated with a reflection layer, for example, a layer of Ag or Al. These synthetic resin disks are known by the names of Laser Vision and Compact Disc. The information track of such matrices and synthetic resin disks has a crenellated profile of information areas situated at a higher and at a lower level. The areas are read in reflection by means of laser light. The difference in height between the areas is 0.05-0.2 um and the longitudinal dimensions vary between 0.3 and 3 um. Another type of disk is a data storage disk. Information bits are formed in the said disk by exposure to pulsated laser light. These disks comprise a recording layer of, for example, a dye, a layer of metal, for example. Bi or a Te-Se alloy. The recording disks comprise a serve track which may comprise optically readable information.

The master disk consists of a flat polished glass plate which comprises on one side a layer of a photoresist which usually is positively active. An example of a suitable photoresist is a resist on the basis of novolak and orthonaphtoquinche diazide. The photoresist layer is modulated, for example, with laser light in the form of a pattern, as a result of which the exposed parts become soluble in a basic solution of, for example, NaOH in water, in order to improve the bonding between the glass plate and the photoresist, a bonding layer is provided on the glass plate before the photoresist layer is provided. A suitable bonding layer is, for example, titanium acety: acetonate.

The synthetic resin information disks are manufactured by means of the metal matrices by means of injection-moviding, compression or UV polymerisation. Conventionally used synthetic resins are polymethylmethacrylate, polyparodnate and UV-polymerisable (meth)acrylate monomer mixtures.

A method of the type mentioned in the opening paragraph is disclosed in United States Patent Specification US 4,550,735. In said Specification is mentioned the use of an electroless nickel-plating bath for providing the conductive layer on the photoresist layer. As an alternative possibility for a conductive layer is mentioned the vapour-deposition or electroless deposition of Ag. Such a conductive metal layer is necessary for the electrodeposition thereon of a thick metal shell. The said metal shell is usually of nickel and is electrodeposited from a nickel-plating bath.

A disadvantage of Ag as a conductive layer is that the said metal is soft and hence is subject easily to damage and moreover is racicly corroded in SO₂ or H₂S-containing ambient air. Electroless Ni as a conductive layer has for its advantage that it is harder and is better resistant to detrition than Ag and is even harder than electrodecosited Ni. The hardness and resistance to detrition of electroless Ni is caused by the presence of B or P in the decosited Ni, originating from the reducing agent used of the electroless Ni-bath, namely dimethylaminoborane and sodium hypophosphite, respectively. The electroless deposited Ni is very suitable for growing an Ni-layer thereon by electrodeposition. The said United States Patent Specification US 4.650 T35 does not state how electroless Ni can be provided on the master disk with sufficient bonding strength. The surface of the master disk to be nickel-plated consists of different materials, namely prodoresist and glass. The glass is present in those sites which are exposed to the laser light and are dissolved by the basic developer in other words, on the bottom of the information track. Remaining bonding agent, for example, titanium spetyl acetonate, may also be present.

In order to be able to electroless nickel-plate such a varied surface with a sufficiently bonding Ni-layer, the surfaces to be moxel-class should comprise sufficient hydroxy groups. These hydroxyl groups are necessary for the absorption of Sh^2 -ions originating from the conventionally used sensitiser solution. The said adsorption Sh^2 -ions are then exphanged with Pd^2 -ions originating from the conventionally used nucleating solution, absorption Polimetal nuclei and Sh^4 -ions being formed. Nickel is deposited in an electroless Ni-boath on surfaces comprising absorption Polimetal, the Ni^2 -ions present being reduced to Ni-

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mara and the replant agent present deing dividised instead of these solutions comprising the and da adium one of the information track is lost. Other known pre-treatment methods for glass and synthetic resins are dorona and UV-coope treatments. In these treatments the surface is exposed to short-wave UV-light of approximately 200 nm, however, this short-wave UV-light dauses a further polymerisation of the photoresist ayer, as a result of which the photoresist layer becomes inscribed and residues of the photoresist layer which in the separation of the lather matrix from the master disk remain on the former, cannot be removed any longer.

One of the objects of the invention is to provide a method of the type mentioned in the opening paragraph which poviates the disadvantages mentioned hereinbefore.

According to the invention, this object is achieved by means of a method as described in the opening paragraph which is pharacterised in that, before the electroless nickel layer is provided, the surfaces to be nickel-plated are treated successively with a detergent and a solution of aminosilane. It has been found that petergents cause sufficient hydroxy groups on the photoresist layer and the glass surface, in which the lineness of the information track is maintained. A suitable aminosilane is, for example, N-ceta-aminoethylaminocropy timesthoxysilane which is known under the tradename Silaan A1120 of Union Carbide Corp., Other aminosilanes may also be used.

An embediment of the method according to the invention is characterised in that sodium lauryl sulphate is used as a detergent.

A preferred emcodiment of the method according to the invention is characterised in that the electroless nickel-piating bath comprises sodium benzene disulphonate. Electrodeposited or electroless deposited metal layers generally show tensile stresses. As a result of the said tensile stresses the metal layer may work loose from the substratum and/or undesired crackle structure is formed in the metal layer. It will be obvious that this is disastrous for the manufacture of the metal matrices having a very fine information pattern, it has been found surprisingly that the addition of approximately 1 g/l of sodium benzene disulphonate to the electroless nickel-plating bath causes the internal stresses in the deposited nickel layer to be reduced considerably so that delamination and crackle phenomena no longer occur. The sodium benzene disulphonate has no detrimental influence on the electroless nickel-plating process, such as reduced deposition rate or reduced hardness and resistance to detrition of the deposited nickel.

An embodiment of the method according to the invention is characterised in that, after the treatment with aminostiane, the surfaces to be nickel-plated are treated with tannin. Tannin, also known as tannic acid, is a pentagailoly glucose compound. The substance is used in the form of an aqueous solution. The substance may obtained to amprise water-miscible organic solvents, for example, an alcohol. The concentration of tannin may be chosen between wide limits and is, for example, from 0.01 to 10 g per litre. Such a treatment with tannin does not make the said pre-treatment with aminosilane superfluous, but is does have a favourable effect on the bonding of the nicker layer.

The pre-treatment solutions for the electroless nickel-plating process may be sprayed, nebulised, coured, etc., on the surface of the master disk. Dipping the master disk in the various solutions is also possible. These methods may also be used for the electroless nickel-plating process.

The invention will now be described in greater detail with reference to the ensuing specific example and the accompanying figures, in which:

Figure 1 is a diagrammatic sectional view of a master disk.

Figure 2 is a diagrammatic sectional view of a master disk having an electroless deposited nickel layer.

Figure 3 is a diagrammatic sectional view of a master disk having an electroless deposited nickel layer and an electrodecosited metal layer.

Figure 4 is a diagrammatic sectional view of a father matrix.

Scecific example:

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Reference numeral tilin Figure tildenotes a 5 mm thick glass plate having a diameter of 240 mm. The said grass plate is provided on the side with a bonding layer of stanium acetyl acetonate (not shown). The said conding layer is provided by means of spraying of a 0.5% solution of a mixture of stanium acetyl acetonate - sporoparci in methy butty ketone, after which the solvent is evaporated.

A photoresist, ayer 2 is then provided on the bonding, ayer and after drying has a thickness of 0.12 mm.

The positive photoresist used is now also having orthonachtequinone diazide as a photosensitive substance. The resist layer is exposed to puisated laser light (wavelength 458 nm) which is modulated in accordance with the information to be recorded. The resist layer thus exposed in the form of a pattern is developed with a solution of 10 g of NaOH and 50.5 g of Na₂P₂O₇.10H₂O in 4.5 I of water. As a result of this the exposed parts of the photoresist layer are dissolved and a spiral-like information track 3 is formed which has a preheliated profile of information areas 4 situated at a higher level alternated by information areas 5 situated at a lower level. The ionigitudinal dimensions of the areas vary from approximately 0.3 to 3 µm in accordance with the stored information. The difference in height between the information areas is approximately 0.1 µm. The master disk is then dipped in a solution of 0.1 g of sodium lauryl sulphate per litre of water for 5 minutes. Finsing is then carried out with deionised water for 1 minute. The solutions hereinafter are used for the following treatments:

Aminosilare solution

4 ml of Silane A1120 (product of Union Caroide Corp.) are dissolved in 400 ml of deionised water.

Tannin solution

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20 1.2 g of tannin are dissolved in 400 mil of deionised water.

Sn2 sclution

5 ul of an RNA solution (product of London Laboratories Ltd.) are dissolved in 400 ml of deionised water.

Ag solution

0.8 ml of an MS-IL solution (product of London Laboratories Ltd.) are dissolved in 400 ml of deionised water.

Pd2° solution

100 mg of $PdCl_2$ are dissolved in 3.5 ml of concentrated hydrochloric acid. The solution is made up to 1 litre by means of delonised water.

The photoresist side of the master disk is provided with the above-mentioned pre-treating solutions by pouring in the sequence hereinafter, rinsing with deionised water being carried out for 1 minute after each pre-treating step.

Aminosilane solution	3 minutes		
Tannin solution	1 minute		
Sn ² solution	1.5 minutes		
Ag solution	1 minute		
Pd ² solution	1.25 minutes.		

The master disk thus pre-treated is then nickel-plated in an electroless nickel-plating bath. For that purpose the following solutions were prepared:

Stock solution A:	NiSO4.6H2O	50 g
	Na. P2 O7.10H2O	100 g
1	deionised water	950 mi

The resulting solution is brought at a pH of 9.4 by means of concentrated ammonia. The solution is then made up to 1 litra with delonised water.

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Stack so Lapan B.	zimetny aminocerane	3 ;
	deionised water	: litre

Equal volumes of stock solutions A and B are combined. The formed solution is brought to a pH of 9.2 by means of an acuerus misc. 150% by weight) solution. 1,110 g of sodium benzene disciononate are then dissolved in the said solution. The temperature of the solution is raised to 45°C, 400 millof the fastmentioned solution are course on the photoresist side of the pre-treated master disk. After approximately 10 30 minutes a 100 nm trick Ni-ayer 3 (see Figure 2) has been deposited on the photoresist layer and on the giass surface 5. The Ni-layer comprises a few per cent, by weight of solution B originating from the reduction agent dimethy/aminocorane.

A nickel layer 7 (see Figure 3) is electrodeposited on the Ni-layer 6 in a thickness of 300 mm. The electroless Ni-ayer is connected as cathode in a bath having, for example, the following composition:

Nickel sulonamate	450 g/l
NiCl ₂ .2H ₂ O	5 ç/!
Boric acid	45 g/l

The temperature of the bath is 45°C and the pH has a value of 4.0. The Ni-layer is deposited with a current density of approximately 15 A/dm2.

The metal shell consisting of the Ni-layer 7 and the electroless Ni-layer 6 conded thereto is pulled from the photoresist 'ayer 2 (see Figure 4). The information track 3 present in the metal shell is a negative copy of the information track 1 (Figure 1). The negative copy-is-termed-father matrix.-Residues, if any, of the prictoresist layer remaining on the father matrix can be removed by means of the developer solution already mentioned, if the photoresist layer, after developing the parts exposed in the form of a pattern, is exposed completely with, for example, a 500 W super high pressure Hg-lamp for 4 minutes. Usually a metal copy (mother matrix) is manufactured from the father matrix by passivating the surface of the nickel layer 6 by a treatment with an aqueous solution of K2Cr2O7 and then electrodepositing an Ni-layer on the side of the information track 3. After separating the last mentioned Ni-layer from Ni-layer 6, 7, the mother matrix is obtained. From this mother matrix, son matrices can be manufactured by electrodeposition in the same manner as stated here-noetore. Synthetic resin information carriers are manufactured by means of the son matrices by using, for example, an injection-moulding process. Both the father matrix, the mother matrix, the son matrix and the synthetic resin information partiers have an excellent surface quality.

Claims

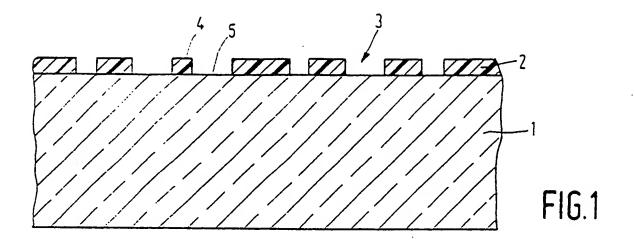
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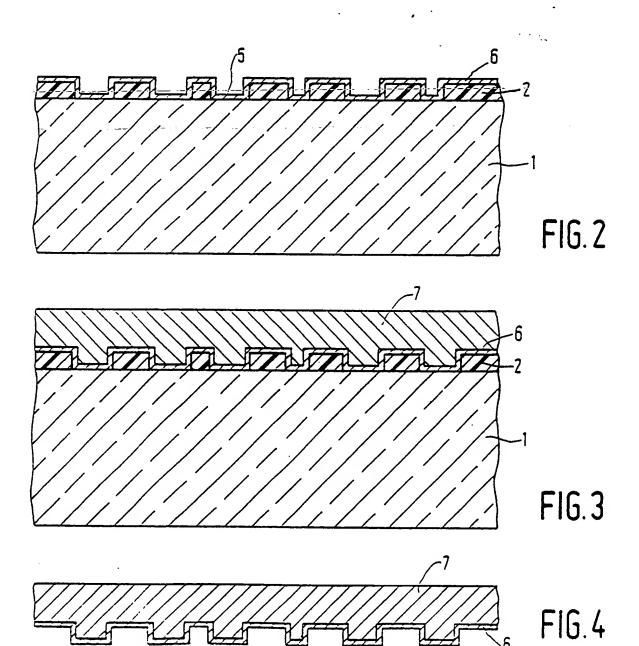
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- 1. A method of manufacturing a metal matrix which comprises an information track on at least one side, in which a master disk comprising a photoresist layer in which an information track has been provided on the side of the chotoresist layer is provided in an electroless nickel-plating bath with a nickel layer on which a metal layer is electrodecosited and the resulting metal shell in which the information track of the chotoresist layer has been copied, is separated from the master disk, characterised in that, before the electroless nickel layer is provided, the surfaces to be nickel-plated are treated successively with a detergent and a solution of aminosilane.
 - 2. A method as claimed in Claim 1, characterised in that the detergent used is sodium lauryl sulphate.
- 3. A method as claimed in Claim 1 or 2, characterised in that the electroless nickel-clating bath comprises sodium benzene disulphonate.
 - 4. A method as claimed in Claim 1, 2 or 3, characterised in that, after the treatment with aminosilane. the surfaces to be nickel-plated are treated with tannin.







EP 89 20 2243

ategory	Citation of document with indication, w	here appropriate,	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int. Cl.5)
A	WO-A-8 802 412 (MACDERMID	INC.)		C 23 C 18/18
A	US-A-3 094 430 (SKWIERINS	KI)		
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				TECHNICAL FIELDS SEARCHED (Int. Cl.5)
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	The present search report has been drawn	up for all claims Date of completion of the search	<u> </u>	Exampler
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